

Best Available Copy**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE****In re the application of:** Phillip S. Wilson**Group Art Unit:** 3726**Application Number:** 09/857,767**Examiner:** Omgba, Essama**Filed:** 06/11/2001**Title:** METHOD AND APPARATUS FOR BLOW MOLDING LARGE
REINFORCED PLASTIC PARTS**DECLARATION UNDER 37 CFR § 1.131**

Honorable Commissioner of Patents & Trademarks
P.O. Box 1450
Alexandria, VA 22313-1450, U.S.A.

Sir:

City of Columbus
State of Ohio,

I, Phillip S. Wilson, declare that all statements made of my own knowledge are true, and that all statements made on information and belief are believed to be true:

1. I am an applicant of the above-identified patent application and an inventor of the subject matter described and claimed therein.
2. Prior to December 22, 1997, I conceived the idea of a method and apparatus for blow molding large reinforced plastic parts as described and claimed in the above noted patent application.
3. Prior to December 22, 1997 I have sent a memo to executives at Magna International Inc., viz. Graham Orr, Bill Fike, Bill Frederiksen, Al Power, and Don Walker. A copy of this memo is attached to this declaration and marked as Exhibit A. On the advice of patent counsel, I have blacked out the date of the memo. In this memo, I have expressed the use of nanocomposite polymers and their applications in various

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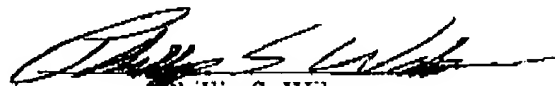
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automotive products. Therein, I proposed to disperse nanoparticle reinforcements into polymer systems to form nanocomposites. Nanoparticle reinforcements can be used in place of conventional glass fibers and/or mineral fillers. Furthermore, the memo states, inter alia, that the use of nanoparticle reinforcements would include specific advantages or uses in lower cost tooling processes, such as blow molding.

4. I believe there were no undo delays and state that no undo delays were the result of my actions during that period.

5. I acknowledge that willful false statements and the like are punishable by fine and/or imprisonment, and may jeopardize the validity of the application or any patent issuing therefrom.

Sworn at the city of Columbus in the
State of Ohio, this eighth day of
January, 2004


Phillip S. Wilson